High Temperature Strain Measurement With a Resistance Strain Gage

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ABSTRACT

A PdCr based electrical resistance strain gage was demonstrated in the laboratory to be a viable sensor candidate for static strain measurement at high temperatures. However, difficulties were encountered while transferring the sensor to field applications. This paper is therefore prepared for recognition and resolution of the problems likely to be encountered with PdCr strain gages in field applications. Errors caused by the measurement system, installation technique and lead wire attachment will be discussed. The limitations and some considerations related to the temperature compensation technique used for this gage will also be addressed.

INTRODUCTION

A PdCr/Pt dual-element temperature-compensated strain gage was developed at NASA Lewis Research Center to meet the urgent need of measuring static strain at elevated temperatures. In applications such as advanced gas turbine engine and hypersonic vehicle ground tests, a sensor is required to operate at temperatures much higher than the present static strain gage technology can provide. Previous results obtained in the laboratory from this newly developed PdCr based gage suggested that the gage factor and the apparent strain of this gage were not very temperature sensitive. The apparent strain was not only small (within 1200 microstrain, με) but also repeatable (within 100 με) between thermal cycles to 1470°F [1]. The apparent strain of this gage can therefore be corrected to within a reasonable error up to this high temperature. The gage was then evaluated and determined by Pratt & Whitney (P&W-GESP) to be the only viable sensor candidate to measure static strain at temperatures up to 1400°F [2]. P&W’s room temperature fatigue testing also indicated that this PdCr gage was comparable to the standard dynamic strain gage currently used in gas turbine engine testing. It is therefore a potential candidate for measuring dynamic strain in the turbine environment.

However, difficulties were encountered when transferring the sensor from the laboratory to field applications. The gage’s performance obtained in the field was not as good as what was obtained in the laboratory. Successfully obtaining data from this sensor is highly dependent on factors such as the purity of the gage wires, the purity of the installation materials, the quality of the installation technique and the stability of the measurement system. Lack of control in any of these areas could drastically affect the performance of the gage. This paper is therefore prepared to identify and to provide resolution for the problems likely to be encountered with PdCr strain gages. The effects of the causes of errors on the performance of the gage will be discussed. Various components of the gage and the measuring system will be addressed to make the gage more compatible with field applications.

Also, in applications such as the National Aerospace Plane (NASP), it is difficult to perform apparent strain calibration on the actual hardware for an individual gage. The prediction and correction of the apparent strain to within specified accuracy limits are a challenge because the corrections must be based on the results of previous tests.
on samples of gages. The estimation of the prediction accuracy for this PdCr gage, and some considerations related
to the temperature compensation technique used in this gage which limit the accuracy of this prediction will also be
addressed in this paper.

ERRORS ASSOCIATED WITH MATERIAL PURITY AND INSTALLATION TECHNIQUE

The PdCr based temperature-compensated strain gage has a dual element: the gage element is 1 mil PdCr wire and
the compensator element is 1 mil Pt wire. The three lead wires extending from the gage system are 3 mil PdCr
wires with a common lead wire shared by both the gage and the compensator, Fig. 1. The gage grid length is
approximately 0.25" and the gage width is approximately 0.125".

Fig. 1. A PdCr/Pt dual-element temperature-compensated wire gage with the tape frame used for flame-spray
mounting.

Both PdCr and Pt were found to be very sensitive to contamination. The presence of impurities changed the linearity
and the stability of the electrical resistivity of the element resulting in a drastic effect on the performance of the
resistance strain gage. The impurities can be introduced during either the wire manufacturing stage or the gage
winding process. Both processes therefore should be tightly controlled to ensure an optimal strain gage assembly.
Both wires should also be inspected to insure the impurity level is below 0.1% when a new batch of wire is used.

Depending on the maximum operating temperature, the gage can be mounted on the test article with either ceramic
cements or a flame-sprayed technique [3]. Since sources of silica contamination can be found in the flame-spray
materials, ceramic cements and the holding tapes (both carrier and masking), attention must be paid to the application
technique. The purity of the flame-sprayed materials and cements has to be verified before application. The residue
of silicon from the holding tape has to be completely removed during installation. A cooling system is necessary
during the flame-spray process to prevent the gage assembly from overheating, and quick passes of the flame-spray
gun with long intervals between passes is desired. A detailed description of the installation technique for this gage
can be found in P&W's NASA contract report [2].
The effect of temperature change on this gage is minimized by connecting a compensator element \( R_c \) to the adjacent arm of a Wheatstone bridge circuit, as shown in Figure 2. The bridge is balanced at room temperature by properly adjusting the value of the ballast resistor \( R_b \) and the bridge completion resistor \( R_1 \) such that 
\[
\frac{R_b}{R_b+R_2} = \frac{R_2}{R_2+R_c+R_b}.
\]

**Fig. 2.** A resistance strain gage Wheatstone bridge completion network for temperature compensation.

The ballast resistor \( R_b \) and the bridge completion resistors \( R_1 \) and \( R_2 \) should be as stable as the active strain gage. In the laboratory test, these resistors are high precision, low drift decade boxes. Because of their large size, their replacement in the field test is necessary, especially when a large number of gages are tested at the same time. The conventional signal conditioning unit equipped with a bridge completion network and amplifier can be used to replace the bridge completion network only if its stability and lack of drift are verified before actual testing. The excitation voltage should drift less than 5 ppm in 24 hours and exhibit noise level less than 10 ppm peak-to-peak rms. The excitation voltage should not exceed 2 volt to minimize self-heating. A miniature, variable resistance device such as a potentiometer can be used as the ballast resistor in a half bridge configuration if its thermal drift coefficient is less than ±10 ppm°F, and its size is small enough to be conveniently attached to the signal conditioning unit.

The temperature compensation technique used here provides the ability to use the gage on materials with a wide range of thermal expansion coefficients by varying the parameters of a simple external circuit \( R_c, R_1, \) and \( R_2 \). However, in order to determine the best value of ballast resistor for compensation, a pre-calibration process is needed to experimentally measure the value of \( R_c, \alpha_g \) and \( \alpha_c \) because they are a function of the substrate and the lead wire.\[\]

**Errors Associated with Measurement Systems and Procedures**

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materials. This pre-calibration process is best done on the test article if a thermal cycle to the maximum use temperature is allowed [3].

Fig. 3 presents the residual apparent strain of four PdCr gages; two were on a 6-ply SCS6/B21S Titanium Matrix Composite (TMC) coupon and two were on an IN100 coupon. The gages were tested after they were installed on the test specimen, and a pre-calibration process was run to obtain the ballast resistor value for each compensating circuit. It can be seen that the apparent strain characteristics of these four gages on two different substrate materials are very similar. The effective resistance of the gage and compensator, the effective temperature coefficients of resistance of the gage and compensator together with the ballast resistor values for these four gages are listed in Table I. For example, looking at the gages on the IN100 coupon, the differences in the effective gage resistances (or effective compensator resistances) between the two gages is only 0.3 ohm (or 0.05 ohm), and the difference in the ballast resistor value needed for compensating the two gages is 1.1 ohm. This results in a difference in apparent strain of approximately 200 με between two gages (Fig. 3b). This result indicates that if characterization of the apparent strain of the gages can not be done on the test article after they are pre-calibrated to obtain Rb value, then the accuracy in predicting and correcting the apparent strain based on the previous results obtained from gages on a simulating coupon can be made to be within 200 με. However, a large number of gages will need to be tested in order to accumulate the necessary statistical accuracy.

![Graph](image)

Fig. 3. The residual apparent strain of (a) two gages on a 6-ply, SCS6/B21S TMC coupon, and (b) two gages on an IN100 coupon.

<table>
<thead>
<tr>
<th>Gages</th>
<th>$R_g$ (ohm)</th>
<th>$R_c$ (ohm)</th>
<th>$\alpha_g$ (ppm/F)</th>
<th>$\alpha_c$ (ppm/F)</th>
<th>$R_b$ (ohm)</th>
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<tr>
<td>#1, on TMC</td>
<td>128.16</td>
<td>18.13</td>
<td>104.71</td>
<td>1035.10</td>
<td>161.0</td>
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<td>129.09</td>
<td>18.29</td>
<td>104.19</td>
<td>1012.83</td>
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<td>Difference</td>
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<td>0.16</td>
<td>0.52</td>
<td>22.27</td>
<td>1.5</td>
</tr>
<tr>
<td>#3, on IN100</td>
<td>126.30</td>
<td>17.12</td>
<td>110.61</td>
<td>1052.74</td>
<td>145.8</td>
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<tr>
<td>#4, on IN100</td>
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<td>17.07</td>
<td>110.27</td>
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<tr>
<td>Difference</td>
<td>0.30</td>
<td>0.05</td>
<td>0.34</td>
<td>6.4</td>
<td>1.1</td>
</tr>
</tbody>
</table>
CONCLUSION

The PdCr/Pt dual-element temperature-compensated gage is a viable sensor candidate for static strain measurements at high temperatures. However, successfully obtaining data from this gage is highly dependent on the purity of the gage materials, the installation materials, the quality of the installation technique and the stability of the measurement system. Attention must be paid to every stage of the applications. This PdCr based gage is best used when a pre-calibration cycle and an apparent strain characterization cycle are run after the gage is installed on the test specimen and before it is used to measure strain. Two such thermal cycles to the maximum use temperature are needed to provide data for adjusting the compensation circuit and a residual apparent strain curve for later corrections. Statistical work is needed on this gage to insure the accuracy in predicting and correcting the apparent strain in applications such as the NASP where the first thermal cycle data is needed and the pre-calibration and pre-characterization processes done on the actual hardware is difficult.

REFERENCES


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